

# dsPIC33EPXXX(GP/MC/MU)806/810/814 and PIC24EPXXX(GP/GU)810/814

# dsPIC33EPXXX(GP/MC/MU)806/810/814 and PIC24EPXXX(GP/GU)810/814 Family Silicon Errata and Data Sheet Clarification

The dsPIC33EPXXX(GP/MC/MU)806/810/814 and PIC24EPXXX(GP/GU)810/814 family devices that you have received conform functionally to the current Device Data Sheet (DS70616**F**), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in Table 1. The silicon issues are summarized in Table 2.

The errata described in this document will be addressed in future revisions of the dsPIC33EPXXX(GP/MC/MU)806/810/814 and PIC24EPXXX(GP/GU)810/814 silicon.

Note: This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated in the last column of Table 2 apply to the current silicon revision (B1).

Data Sheet clarifications and corrections start on page 15, following the discussion of silicon issues.

The silicon revision level can be identified using the current version of MPLAB® IDE and Microchip's programmers, debuggers and emulation tools, which are available at the Microchip corporate web site (www.microchip.com).

For example, to identify the silicon revision level using MPLAB IDE in conjunction with MPLAB ICD 3 or PICkit™ 3:

- Using the appropriate interface, connect the device to the MPLAB ICD 3 programmer/debugger or PICkit 3
- 2. From the main menu in MPLAB IDE, select <u>Configure>Select Device</u>, and then select the target part number in the dialog box.
- Select the MPLAB hardware too (Debugger>Select Tool).
- Perform a "Connect" operation to the device (<u>Debugger>Connect</u>). Depending on the development tool used, the part number and Device Revision ID value appear in the **Output** window.

**Note:** If you are unable to extract the silicon revision level, please contact your local Microchip sales office for assistance.

The Device and Revision ID values for the various dsPIC33EPXXX(GP/MC/MU)806/810/814 and PIC24EPXXX(GP/GU)810/814 silicon revisions are shown in Table 1.

TABLE 1: SILICON DEVREY VALUES

| Dout November     | Device ID <sup>(1)</sup> | Revision ID for Silicon Revision <sup>(2)</sup> |
|-------------------|--------------------------|---|
| Part Number       | Device ID(*)             | B1  |
| dsPIC33EP256MU806 | 0x1861                   |   |
| dsPIC33EP256MU810 | 0x1862                   |   |
| dsPIC33EP256MU814 | 0x1863                   |   |
| PIC24EP256GU810   | 0x1826                   |   |
| PIC24EP256GU814   | 0x1827                   | 0x4002  |
| dsPIC33EP512MU810 | 0x1872                   |   |
| dsPIC33EP512MU814 | 0x1873                   |   |
| dsPIC33EP512GP806 | 0x187D                   |   |
| dsPIC33EP512MC806 | 0x1879                   |   |

- **Note 1:** The Device and Revision IDs (DEVID and DEVREV) are located at the last two implemented addresses in program memory.
  - **2:** Refer to the "dsPIC33E/PIC24E Flash Programming Specification" (DS70619) for detailed information on Device and Revision IDs for your specific device.

TABLE 1: SILICON DEVREV VALUES (CONTINUED)

| Part Number     | Device ID <sup>(1)</sup> | Revision ID for Silicon Revision <sup>(2)</sup> |
|-----------------|--------------------------|---|
| Part Number     | Device ID(**)            | B1  |
| PIC24EP512GU810 | 0x1836                   |   |
| PIC24EP512GU814 | 0x1837                   | 0x4002  |
| PIC24EP512GP806 | 0x183D                   |   |

- **Note 1:** The Device and Revision IDs (DEVID and DEVREV) are located at the last two implemented addresses in program memory.
  - **2:** Refer to the "dsPIC33E/PIC24E Flash Programming Specification" (DS70619) for detailed information on Device and Revision IDs for your specific device.

TABLE 2: SILICON ISSUE SUMMARY

| Module             | Feature                   | Item<br>Number | Issue Summary   | Affected<br>Revisions <sup>(1)</sup> |
|--------------------|---------------------------|----------------|---|--------------------------------------|
|                    |                           | Number         |   | B1                                   |
| I/O<br>Multiplexer | Open Drain<br>Feature     | 1.             | The open drain control signal from GPIO, PORTA bit 3, is inadvertently controlling the data output of bit 15 of PORTC.  | Х                                    |
| CPU                | DSP DO<br>Instruction     | 2.             | The assembly language DO instruction does not function correctly with nested loops when the inner loop count is zero (one iteration).   | Х                                    |
| CPU                | div.sd<br>Instruction     | 3.             | When using the div.sd instruction, the overflow bit is not getting set when an overflow occurs.   | Х                                    |
| PPS                | Virtual Remap             | 4.             | Virtual pin remapping does not work correctly.  | Х                                    |
| SPI                | Frame Sync<br>Pulse       | 5.             | Frame sync pulse not generated in Master mode when FRMPOL = 0.  | Х                                    |
| SPI                | Frame Sync<br>Pulse       | 6.             | When in SPI Slave mode, with the frame sync pulse set as an input, FRMDLY must be set to '0'.   | Х                                    |
| PWM                | Dead Time<br>Compensation | 7.             | The duty cycle is not correct when using dead time and the programmed duty cycle is close to 0% or 100%.  | Х                                    |
| PWM                | Dead Time<br>Compensation | 8.             | Dead Time Compensation is not enabled for Center Aligned PWM Mode.  | Х                                    |
| Power<br>System    | BOR                       | 9.             | BOR must always be enabled.   | Х                                    |
| Reserved           | _                         | 10.            | _   | _                                    |
| ECAN™              | CANCKS                    | 11.            | The function of the CANCKS bit is reversed.   | X                                    |
| ECAN               | ERRIF                     | 12.            | The ERRIF status bit does not get set when a CAN error condition occurs.  | X                                    |
| USB                | LS through<br>Hub         | 13.            | The USB bus might not be returned to the J-state following an acknowledgement packet when running low-speed through a hub.  | X                                    |
| USB                | UIDLE<br>Interrupt        | 14.            | UIDLE interrupts cease if the UIDLE interrupt flag is cleared.  | Х                                    |
| DMA                | CAN                       | 15.            | Possible loss of interrupts when DMA is used with CAN.  | Х                                    |
| UART               | TX Interrupt              | 16.            | A TX Interrupt may occur before the data transmission is complete.  | Х                                    |
| UART               | UTXBRK                    | 17.            | When a Read-Modify-Write operation is performed to set or clear any bit(s) in the UxSTA register while hardware is clearing the UTXBRK bit, the UTXBRK bit may remain set.              | Х                                    |
| UART               | UARTEN                    | 18.            | The transmitter write pointer does not get cleared when the UART is disabled (UARTEN = 0), it requires TXEN to be set in order to clear the write pointer.                              | Х                                    |
| I <sup>2</sup> C™  | I2CxCON                   | 19.            | When a Read-Modify-Write operation is performed to set or clear any bit(s) in the I2CxCON register while hardware is clearing the ACKEN bit, the ACKEN bit may remain set.              | Х                                    |
| ADC                | DONE bit                  | 20.            | The ADC Conversion Status bit, DONE (ADxCON1<0>), does not indicate completion of conversion when External Interrupt is selected as the ADC trigger source (ADxCON1 <ssrc> = 1).</ssrc> | Х                                    |
| PMP                | _                         | 21.            | On the dsPIC33EPXXXGU814 or PIC2EPXXXMU814 devices, the PMCS1/PMA14 and PMCS2/PMA15 pin functionality is duplicated on the RJ14/15 pins in addition to the expected RK11/RK12 pins.     | Х                                    |

**Note 1:** Only those issues indicated in the last column apply to the current silicon revision.

TABLE 2: SILICON ISSUE SUMMARY (CONTINUED)

| Module             | Feature                  | Item<br>Number | Issue Summary  | Affected<br>Revisions <sup>(1)</sup> |
|--------------------|--------------------------|----------------|--|--------------------------------------|
|                    |                          | Number         |  | B1                                   |
| Flash<br>Memory    | ICSP™                    | 22.            | If either the General or Auxiliary Segment is protected, neither segment can be read.  | Х                                    |
| Flash<br>Memory    | Programming              | 23.            | Stall mechanism may not function properly when erasing or programming Flash memory while executing code from the same Flash segment.   | Х                                    |
| Power<br>System    | Flash<br>Regulator       | 24.            | The RCON <vregsf> bit always reads as '0'.</vregsf>  | X                                    |
| PWM                | Dead Time                | 25.            | When operating in Edge-Aligned Complimentary mode the dead time could become zero.   | Х                                    |
| QEI                | Index Counter            | 26.            | The QEI Index Counter does not count correctly in Quadrature Detector mode.  | Х                                    |
| QEI                | Modulo Mode              | 27.            | Modulo mode functionality is incorrect when the Count Polarity bit is set.   | Х                                    |
| CPU                | DO Loop                  | 28.            | PSV access, including table reads or writes, in the last instruction of a DO loop are not allowed.   | Х                                    |
| PWM                | Master Time<br>Base Mode | 29.            | In Master Time Base mode, writing to the period register and any other timing parameter of the PWM module will cause the update of the other timing parameter to take effect one PWM cycle after the period update is effective. | Х                                    |
| ECAN               | DMA                      | 30.            | Write collisions on DMA enabled ECAN peripheral do not generate DMAC Error traps.  | Х                                    |
| Auxiliary<br>Flash | Interrupt<br>Vector      | 31.            | When a device is set to obtain the reset instruction from Auxiliary Flash location 0x7FFFFC (RSTPRI = 0) and Auxiliary Flash code protection is enabled, the device does not execute the application code after a Reset.         | Х                                    |
| Auxiliary<br>Flash | Interrupt<br>Vector      | 32.            | All interrupts and traps should vector through the single auxiliary interrupt vector when executing from the Auxiliary Segment; however, the Address Error trap is not.  | Х                                    |
| Output<br>Compare  | Interrupt                | 33.            | Under certain circumstances, an Output Compare match may cause the interrupt flag (OCxIF) to become set prior to the change of state of the OCx pin.   | Х                                    |
| ADC                | 1.1 Msps<br>Sampling     | 34.            | Selecting the same ANx input (AN0 or AN3) for CH0 and CH1 to achieve a 1.1 Msps sampling rate results in erroneous readings for CH1.   | Х                                    |

**Note 1:** Only those issues indicated in the last column apply to the current silicon revision.

# Silicon Errata Issues

Note:

This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current. Only the issues indicated by the shaded column in the following tables apply to the current silicon revision (**B1**).

# 1. Module: I/O Multiplexer

The open drain control signal from GPIO PORTA, bit 3, is inadvertently controlling the data output of bit 15 of PORTC.

#### Work around

There is no work around. If bit 15 of PORTC is being used as an output (FOSC<OSCIOFNC> = 0 and TRISC<15> = 0), the open drain capability for bit 3 of PORTA cannot be enabled and used as an open drain output (ODCA<3>  $\neq$  1).

This issue only applies when the OSC2 pin function is set for general purpose digital I/O (FOSC<ISCIOFNC> = 0) and the device is using the FRC or EC Primary Oscillator modes.

#### **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

#### 2. Module: CPU

Note:

This silicon issue applies only to the dsPIC33EPXXXGP/MC/MU806/810/814 devices.

The assembly language DO instruction does not function correctly with nested loops when the inner loop count is zero (one iteration).

# Work around

With nested DO loops where an inner loop can have a single iteration (DCOUNT = 0), one of the following precautions must be taken for proper operation:

- Insert a NOP immediately after the DO instruction, which can contain a loop count of zero, and insert two NOP instructions immediately following the DO instruction of the next outer loop, as shown in Example 1.
- Alternatively, the code can test for a count of zero and branch over the DO instruction for all nested loops. In this case, insertion of NOP instructions is not required.

This issue does not apply if there are no nesting of DO loops or if all of the inner loop counts are always greater than zero. When a nested DO loop has a count of zero, only the immediate next outer loop will be affected.

#### **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Х  |  |  |  |  |

# **EXAMPLE 1:**

```
w0, out lp
                              ; w0 contains the count for the outer loop
                              ; 2 NOPs are added for the work around
       nop
       nop
                              ; user code
       do
                              ; w1 contains count for the inner loop
              w1, in lp
                              ; A Single NOP is the required work around for the inner loop
       nop
                              ; user code
in lp:
                              ; end of inside loop
out lp:
                              ; end of outside loop
```

#### 3. Module: CPU

When using the Signed 32-by-16-bit Division instruction, div.sd, the overflow bit does not always get set when an overflow occurs.

#### Work around

Test for and handle overflow conditions outside of the div.sd instruction.

# **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

# 4. Module: PPS

Virtual pin remapping does not work.

#### Work around

Virtual remapping applies to comparator outputs and the QEI Home and Index functions:

 Comparator outputs can be connected to a peripheral input by mapping both the comparator output and the peripheral input to an unused physical pin using the peripheral pin select feature.

The following example assumes that there is no connection to the RP127/RG15 pin on the device. The following statements connect Comparator Output 1 to Input Capture IC1 using RP127.

```
RPINR7bits.IC1R = 127;
/*assign Input Capture 1 to RP127*/
RPOR15bits.RP127R = 0b011000;
/*assign RP127 to Comparator Output 1*/
```

The FCLCONx register can be used to map comparator outputs to PWM fault inputs without the use of virtual remapping.

The following statement will connect Comparator 1 output to Fault Control Signal Source for PWM 1.

```
FCLCON1bits.FLTSRC = 8;
/* value of 0b01000 selects Comp. 1 */
```

 FHOMEx and FINDXx are not accessible, making the digital filter in the QEI module unusable for any other peripheral besides the QEI. There is no work around.

### **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Х  |  |  |  |  |

#### 5. Module: SPI

When using the frame sync pulse output feature (SPIxCON2<FRMEN> = 1) in Master Mode (SPIxCON2<SPIFSD> = 0), the frame sync pulse is not being generated with an active low pulse (SPIxCON2<FRMPOL> = 0).

# Work around

The SS pin is used as the frame sync pulse when the frame sync pulse output feature is used. Mapping the  $\overline{SSx}$  input function and output function to the same pad using the PPS feature resolves this issue.

The following code example assigns SPI1 SS input and SPI1 SS output to RP118.

```
RPINR21bits.SS1R = 118;
/* assign the SPI1 Slave Select Input to
    RP118 */
RPOR13bits.RP118R = 0b000111;
/* assign peripheral output function SPI1
    to RP118 */
```

#### **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

# 6. Module: SPI

When in SPI Slave mode (SPIxCON1<MSTEN> = 0) and using the frame sync pulse output feature (SPIxCON2<FRMEN> = 1) in Slave Mode (SPIxCON2<SPIFSD> = 0), the Frame Sync Pulse Edge Select bit must be set to '0' (SPIxCON2 <FRMDLY> = 0)

# Work around

There is no work around. The Frame Sync Pulse Edge Select bit cannot be set to produce a Frame sync pulse that coincides with the first bit clock.

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

#### 7. Module: PWM

When dead time compensation is enabled (PWMCONx<DTC> = 11) in Edge-Aligned mode (PWMCONx<CAM> = 0), the setting of the DTCP<1:0> bits (PWMCONx<7:6>) and the external signal DTCMPx, determine whether the DTRx register is added to or subtracted from the duty cycle specified by the PDCx or MDC registers.

When DTR is being subtracted from the duty cycle, the resulting duty cycle will be 0% if the programmed duty cycle, minus two times the DTR value, is less than '0'.

```
Duty Cycle = 0% when (PDCx - 2 DTR) < 0 if MDCS = 0 (PWMCONx<8>) or (MDC - 2 DTR) < 0 if MDCS = 1 (PWMCONx<8>)
```

When DTR is being added to the duty cycle, the resulting duty cycle will be 100% if the programmed duty cycle, plus two times the DTR register, is greater than the period.

```
Duty Cycle = 100% when (PDCx + 2 DTR) \geq Period if MDCS = 0 (PWMCONx<8>) or (MDC + 2 DTR) \geq Period if MDCS = 1 (PWMCONx<8>)
```

The period is specified by the PTPER, STPER or PHASEx registers, depending on the ITB (PWMCON<9>) and MTBS (PWMCONx<3>) bit settings.

Note: The dead time values, as specified in the ALTDTRx register, are not part of the equations shown above, and are still applied when the duty cycle is not forced to 0% or 100%.

# Work around

If using dead time compensation, do not use duty cycle values that are less than two times the DTR value or that are greater than or equal to the period less two times the DTR value.

# **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Х  |  |  |  |  |

#### 8. Module: PWM

When dead time compensation is enabled (PWMCONx<DTC> = 11) in Center-Aligned mode (PWMCONx<CAM> = 1), the dead time, as specified in the ALTDTRx register, is not being applied to the PWMxH output. The leading and trailing edges of the PWMxL output are extended by one-half the value of the ALTDTRx register, but the PWMxH leading and trailing edges are unaffected.

#### Work around

Using the values from **Section 14.** "**High-Speed PWM**" (DS70645), adjust the PWM parameters as follows:

- Subtract one-half of the ALTDTR dead time from PDCx
- Use twice the value for ALTDTR. For example:
  - Frequency of 60 kHz, duty cycle of 50%
  - Desired dead time of 833 ns and dead time compensation of 833 ns

Using the specified values from **Section 14.** "**High-Speed PWM**" (DS70645):

- PHASEx = 1000
- PDCx = 500
- ALTDTR = 833 ns/8.33 ns = 100
- DTR = (833 ns/8.33 ns)/2 = 50

Applying the work around:

- ALTDTR = 2 \* 100 = 200
- PDCx = PDCx 25 = 475

# Affected Silicon Revisions

| B1 |  |  |  |  |
|----|--|--|--|--|
| Х  |  |  |  |  |

# 9. Module: Power System

For this version of silicon, the Brown-out Reset (BOR) must always be enabled.

# Work around

Do not disable the BOR by setting BOREN = 0 (FPOR<3>) or by setting SBOREN = 0 (RCON<13>).

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

### 10. Module: Reserved

# 11. Module: ECAN™

The CANCKS (CiCTRL1<11>) function is reversed.

#### Work around

Set CiCTRL1<CANCKS> = 0 to obtain an FCAN equal to twice FCY or CiCTRL1<CANCKS> = 1 to obtain an FCAN equal to FCY. This bit must be set to '1' for compatibility with the dsPIC33F or PIC24H. At reset it is set to '0'.

# **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

#### 12. Module: ECAN

The ERRIF status flag (CiINTF<5>) does not get set when a CAN error condition occurs, and as a result, an interrupt is not generated even if enabled.

#### Work around

Use the Invalid Message Interrupt (IVRIF) to inspect the individual error condition status flags TXBO, TXBP, RXBP, TXWAR, RXWAR and EWARN (CiINTF<13:8>) to determine if an error condition has occurred.

#### **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Х  |  |  |  |  |

#### 13. Module: USB

While operating in Host mode and attached to a low-speed device through a full-speed USB hub, the host may persistently drive the bus to an SE0 state (both D+/D- as '0'), which would be interpreted as a bus Reset condition by the hub; or the host may persistently drive the bus to a J state, which would make the hub detach condition undetectable by the host.

#### Work around

Connect low-speed devices directly to the Host USB port and not through a USB hub.

#### **Affected Silicon Revisions**

| E | 31 |  |  |  |  |
|---|----|--|--|--|--|
|   | Χ  |  |  |  |  |

#### 14. Module: USB

In the case where the bus has been idle for > 3 ms, and the UIDLE interrupt flag is set, if software clears the interrupt flag, and the bus remains idle, the UIDLE interrupt flag will not be set again.

# Work around

Software can leave the UIDLE bit set until it has received some indication of bus resumption. (Resume, Reset, SOF, or Error).

| Note: | Resume and Reset are the only interrupts     |
|-------|--|
|       | that should occur following UIDLE            |
|       | assertion. If, at any point in time, the     |
|       | UIDLE bit is set, it should be okay to       |
|       | suspend the USB module (as long as this      |
|       | code is protected by the GUARD and/or        |
|       | ACTPEND logic). Note that this will          |
|       | require software to clear the UIDLE          |
|       | interrupt enable bit to exit the USB ISR (if |
|       | using interrupt driven code).                |

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

#### 15. Module: DMA

When the DMA is set up for CAN receive, interrupts can sometimes be lost if the DMA is held in an "OFF" state by the system arbiter. If a CAN receive interrupt occurs while the DMA is waiting for a grant for the previous CAN transaction, this current interrupt will be dropped.

# Work arounds

There are two possible work arounds for this issue:

- Use Dual Port RAM (If available) for target DMA memory; the DMA cannot be held "OFF" when accessing the back side of DPRAM. Only channels set up for CAN receive would need to use DPRAM; all other peripherals can use any RAM.
- Elevate the system priority of DMA by writing a 0x20 to the MSTRPR (Master Priority)
  SFR register (address 0x0058). This will
  also prevent the DMA from being held
  "OFF".

#### **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Х  |  |  |  |  |

#### 16. Module: UART

When using UTXISEL = 01 (Interrupt when last character is shifted out of the Transmit Shift Register), and the final character is being shifted out through the Transmit Shift Register, the TX interrupt may occur before the final bit is shifted out.

# Work around

If it is critical that the interrupt processing occurs only when all transmit operations are complete, after which the following work around can be implemented:

Hold off the interrupt routine processing by adding a loop at the beginning of the routine that polls the transmit shift register empty bit, as shown in Example 2.

#### **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

#### **EXAMPLE 2:**

#### 17. Module: UART

When a Read-Modify-Write operation is performed to set or clear any bit(s) in the UxSTA register while hardware is clearing the UTXBRK bit (UxSTA<11>), the UTXBRK bit may remain set. BSET and BCLR are examples of Read-Modify-Write instructions.

#### Work around

Wait for the UTXBRK bit to get cleared by hardware, before performing a Read-Modify-Write operation on the UxSTA register.

#### **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Х  |  |  |  |  |

#### 18. Module: UART

The transmitter write pointer does not get cleared when the UART module is disabled (UARTEN = 0), and it requires the TXEN bit to be set in order to clear the write pointer.

#### Work around

Do not load data into the TX FIFO (register) before setting the TXEN bit.

#### **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

# 19. Module: I<sup>2</sup>C™

When a Read-Modify-Write operation is performed to set or clear any bit(s) in the I2CxCON register while hardware is clearing the ACKEN bit (I2CxCON<4>), the ACKEN bit may remain set. BSET and BCLR are examples of Read-Modify-Write instructions.

#### Work around

Wait for the ACKEN bit to get cleared by hardware before performing a Read-Modify-Write operation on the I2CxCON register.

# **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Х  |  |  |  |  |

#### 20. Module: ADC

The ADC Conversion Status bit, DONE (ADxCON1<0>), does not indicate completion of conversion when External Interrupt is selected as the ADC trigger source (ADxCON1<SSRC> = 1).

# Work around

Use ADC interrupt or poll ADxIF (in the IFSx registers) bit to determine the completion of conversion.

# Affected Silicon Revisions

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

#### 21. Module: PMP

| Note: | This silicon issue applies only to |
|-------|------------------------------------|
|       | dsPIC33EPXXXMU814 and              |
|       | PIC24EPXXXMC814 devices.           |

When PTEN14 = 1 (PMAEN<14>), the PMA<14> or PMCS1 functionality is present on the PMCS1/RK11 (pin 94) and RJ14 (pin 21).

When PTEN15 = 1 (PMAEN<15>), the PMA<15> or PMCS2 functionality is present on the PMCS2/ RK12 (pin 93) and RJ15 (pin 22).

## Work around

None.

#### **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Х  |  |  |  |  |

# 22. Module: Flash Memory

| Note: | This silicon issue applies only to In- |
|-------|--|
|       | Circuit Serial Programming™            |
|       | (ICSP™) mode.                          |

If code or write protection is enabled on either the General Segment or Auxiliary Segment, neither segment can be read by the programmer. Code or write protection is enabled for the General Segment when the GSS (FGS<1>) or GWRP (FGS<0>) bits are '0'. Code or write protection is enabled for the Auxiliary Segment when the APL (FAS<1>) or AWRP (FAS<0>) bits are '0'.

# Work around

None.

| B1 |  |  |  |  |
|----|--|--|--|--|
| Х  |  |  |  |  |

# 23. Module: Flash Memory

The processor stalls while performing Run-Time Self-Programming (RTSP) erase and write operations on the same Flash segment (General or Auxiliary) from which code is being executed. The stall mechanism does not always function properly and can cause unexpected behavior.

#### **Work arounds**

Two options are available to avoid this issue:

- If you are required to execute code, including an Interrupt Service Routine (ISR), from the same segment (either General or Auxiliary) that you are performing RTSP operations on, you must disable interrupts until the erase or programming operation is complete (see Example 3).
- 2. If possible, structure your project such that RTSP operations are performed on a segment from which no code is being executed. For example, place all of your executable code in the General Segment and all reprogrammable data in the Auxiliary Segment or vice versa. This solution has the added advantage that no CPU stalls occur since the programming operation is not being performed on the same segment that is executing the code.

# **EXAMPLE 3:**

```
; Load write latches if programming
; Setup NVMCON register to erase or program
   as required
; Disable interrupts
   PUSH SR
   MOV
          #0x00E0, W0
         SR
   IOR
; Write the KEY sequence
   MOV #0x55, W0
   MOV WO, NVMKEY
   MOV
         #0xAA, W0
          W0, NVMKEY
   MOV
; Start the programming sequence
   BSET NVMCON, #15
; Insert two NOPs after programming
   NOP
   NOP
; Wait for operation to complete
prog wait:
   BTSC NVMCON, #15
   BRA prog wait
; Re-enable interrupts,
```

# **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

#### 24. Module: Power System

The VREGSF bit functions as documented, but will always read as '0'. Because of the Read-Modify-Write process, any BSET or BCLR instruction of the RCON register will also write a '0' to the VREGSF bit.

# Work around

If the VREGSF bit is intended to be set to a '1', the user must also write a '1' to the VREGSF bit when setting or clearing any other bit in the RCON register.

#### **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

#### 25. Module: PWM

When operating in Edge-Aligned Complimentary mode, if the duty cycle (PDCx) becomes less than the alternate dead time (ALTDTRx), the dead time on the PWMs will become zero.

#### Work around

Ensure that the duty cycle (PDCx) always meets the following condition: PDCx > (ALTDTRx - 1)

#### Affected Silicon Revisions

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

# 26. Module: QEI

In Quadrature Encoder mode (QEIxCON<CMM> = 00), the index counter registers (INDXxCNTH and INDXxCNTL) cannot be relied upon to increment when the last known direction was positive and an index pulse occurs. The index register can decrement even if the last known direction was positive. This does not apply to external clock or internal timer QEI modes.

# Work around

The Index Event can be used to implement a software counter. The direction could be determined by comparing the current POSxCNT value to that of the previous Index Event.

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

# 27. Module: QEI

When Modulo Count mode (Mode 6) is selected for the position counter (QEIxCON<PIMOD> = 110) and the counter direction is set to negative (QEIxCON<CNTPOL> = 1), the functions of the QEIxLEC and QEIxGEC registers are reversed.

# Work around

When using Modulo Count mode in conjunction with a negative count direction (polarity) use the QEIxLEC register as the upper count limit and the QEIxGEC register as the lower count limit.

#### **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

#### 28. Module: CPU

| Note: | This silicon issue applies only to |
|-------|------------------------------------|
|       | dsPIC33EPXXXGP/MC/MU806/810/       |
|       | 814 devices.                       |

Table write (TBLWTL, TBLWTH) instructions cannot be the first or last instruction of a DO loop.

#### Work around

None.

#### Affected Silicon Revisions

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

#### 29. Module: PWM

The PWM module can operate with variable period, duty cycle, dead-time, and phase values. The master period and other timing parameters can be updated in the same PWM cycle. With immediate updates disabled, the new values should take effect at the start of the next PWM cycle.

As a result of this issue, the updated master period takes effect on the next PWM cycle, while the update of the additional timing parameter is delayed by one PWM cycle. The parameters affected by this erratum are as follows:

Master period registers – update effective on the next PWM cycle:

- PTPER if PWMCONx<MTBS> = 0
- STPER if PWMCONx<MTBS> = 1

Additional PWM timing parameters – update effective one PWM cycle after master period update:

- Duty cycle PDCx, SDCx, and MDC registers
- Phase PHASEx or SPHASEx registers
- Dead-time DTRx and ALTDTRx registers and dead-time compensation signals
- Clearing of current-limit and Fault conditions, and application of external period reset signal

# Work around

If the application requires the master period and other parameters to be updated at the same time, enable both immediate updates:

- PTCON<EIPU> = 1 to enable immediate period updates
- PWMCONx<IUE> = 1 to enable immediate updates of additional parameters listed above

Enabling immediate updates will allow updates to the master period and the other parameters to take effect immediately after writing to the respective registers.

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

#### 30. Module: ECAN

When DMA is used with the ECAN module and the CPU and DMA write to a ECAN special function register (SFR) at the same time, the DMAC Error trap is not occurring. In addition, neither the PWCOLx bit of the DMAPWC SFR or the DMACERR bit of the INTCON1 SFR are being set. Since the PWCOLx bit is not set, subsequent DMA requests to that channel are not ignored.

#### Work around

There is no work around; however, under normal circumstances, this situation should not arise. When DMA is used with the ECAN module, the application should not be writing to the ECAN SFRs.

# **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

# 31. Module: Auxiliary Flash

When a device is set to obtain the reset instruction from Auxiliary Flash location 0x7FFFFC (RSTPRI = 0) and Auxiliary Flash code protection is enabled using the FAS register, the device does not execute the application code after a Reset. This configuration causes a Security Trap resulting in a Reset.

# Work around

The work around is dependent on errata issue 22 (Flash Memory) provided that the application will accept both segments being code protected. The Auxiliary Flash Reset Vector (RSTPRI = 0) does function when code protection for the Auxiliary Segment is not enabled using the FAS register. Enabling code protection on the General Segment using the FGS register protects the General Segment and, because of errata issue 22, the Auxiliary Segment is protected as well.

#### **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

# 32. Module: Auxiliary Flash

When executing code in the Auxiliary Segment, all interrupts and traps should vector through the single auxiliary interrupt vector located at address 0x7FFFFA; however, the Address Error trap is not. Instead, it vectors to the Address Error Trap vector located at address 0x000006 in the General Segment.

# Work around

There is no universal work around. In a Bootloader application, if the General Segment is erased and an address error trap occurs, a Reset will result. If the application routinely executes code from both segments, the error address trap could then be made to handle either circumstance. A flag could be set to indicate code is executing from the Auxiliary Segment and tested by the address error trap handler.

## **Affected Silicon Revisions**

| B1 |  |  |  |  |
|----|--|--|--|--|
| Х  |  |  |  |  |

# 33. Module: Output Compare

Under certain circumstances, an Output Compare match may cause the interrupt flag (OCxIF) to become set prior to the change of state of the OCx pin. This has been observed when all of the following are true:

- The module is in One-Shot mode (OCM<2:0> = 001, 010 or 100);
- One of the timer modules is being used as the time base; and
- A timer prescaler other than 1:1 is selected

If the module is reinitialized by clearing OCM<2:0> after the One-Shot compare, the OCx pin may not be driven as expected.

# Work around

After OCxIF is set, allow an interval (in CPU cycles) of at least twice the prescaler factor to elapse before clearing OCM<2:0>. For example, for a prescaler value of 1:8, allow 16 CPU cycles to elapse after the interrupt.

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

# 34. Module: ADC

Selecting the same ANx input (AN0 or AN3) for CH0 and CH1 to achieve a 1.1 Msps sampling rate results in erroneous readings for CH1.

# Work around

Bring the analog signal into the device using both AN0 and AN3, connect externally, and then assign one input to CH0 and the other to CH1.

If selecting AN0 on CH1 (CH123Sx = 0), select AN3 on CH0 (CH0Sx = 3). Conversely, if selecting AN3 on CH1 (CH123Sx = 1), select AN0 on CH0 (CH0Sx = 0).

| B1 |  |  |  |  |
|----|--|--|--|--|
| Χ  |  |  |  |  |

# **Data Sheet Clarifications**

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS70616F):

**Note:** Corrections are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

None to report at this time.

# **APPENDIX A: REVISION HISTORY**

# Rev A Document (6/2011)

Initial release of this document; issued for revision B1 silicon.

Includes silicon issues 1 (I/O Multiplexer), 2-3 (CPU), 4 (PPS), 5-6 (SPI), 7-8 (PWM), 9 (Power System), 10 (Reserved), 11-12 (ECAN $^{\text{TM}}$ ), 13-14 (USB), 15 (DMA) 16-18 (UART), and 19 (I $^{2}$ C $^{\text{TM}}$ ).

# Rev B Document (11/2011)

Updated issues 2 (CPU), 7 (PWM), 8 (PWM), 12 (ECAN $^{TM}$ ), and 14(USB).

Added issues 20 (ADC), 21 (PMP), 22 (Flash Memory), 23 (Flash Memory), 24 (Power System), 25 (PWM), 26 (QEI), 27 (QEI), 28 (CPU), and 29 (PWM).

# Rev C Document (3/2012)

Added silicon issues 30 (ECAN), 31 (Auxiliary Flash), 32, (Auxiliary Flash), 33 (Output Compare), and 34 (ADC).

| •   | , | PXXX(GP/GU)810 |  |
|-----|---|----------------|--|
| ES: |   |                |  |
|     |   |                |  |
|     |   |                |  |
|     |   |                |  |
|     |   |                |  |
|     |   |                |  |
|     |   |                |  |
|     |   |                |  |
|     |   |                |  |
|     |   |                |  |
|     |   |                |  |
|     |   |                |  |
|     |   |                |  |
|     |   |                |  |
|     |   |                |  |
|     |   |                |  |

# Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our
  knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data
  Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

#### **Trademarks**

The Microchip name and logo, the Microchip logo, dsPIC, Keeloq, Keeloq logo, MPLAB, PIC, PICmicro, PICSTART, PIC<sup>32</sup> logo, rfPIC and UNI/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

FilterLab, Hampshire, HI-TECH C, Linear Active Thermistor, MXDEV, MXLAB, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Analog-for-the-Digital Age, Application Maestro, chipKIT, chipKIT logo, CodeGuard, dsPICDEM, dsPICDEM.net, dsPICworks, dsSPEAK, ECAN, ECONOMONITOR, FanSense, HI-TIDE, In-Circuit Serial Programming, ICSP, Mindi, MiWi, MPASM, MPLAB Certified logo, MPLIB, MPLINK, mTouch, Omniscient Code Generation, PICC, PICC-18, PICDEM, PICDEM.net, PICkit, PICtail, REAL ICE, rfLAB, Select Mode, Total Endurance, TSHARC, UniWinDriver, WiperLock and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2011-2012, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

Printed on recycled paper.

ISBN: 978-1-62076-150-2

# QUALITY MANAGEMENT SYSTEM CERTIFIED BY DNV = ISO/TS 16949=

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.



# Worldwide Sales and Service

#### **AMERICAS**

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199

Tel: 480-792-7200 Fax: 480-792-7277 Technical Support:

http://www.microchip.com/

support Web Address: www.microchip.com

Atlanta Duluth, GA

Tel: 678-957-9614 Fax: 678-957-1455

**Boston** 

Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL

Tel: 630-285-0071 Fax: 630-285-0075

Cleveland

Independence, OH Tel: 216-447-0464 Fax: 216-447-0643

**Dallas** 

Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit

Farmington Hills, MI Tel: 248-538-2250 Fax: 248-538-2260

Indianapolis Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453

Los Angeles

Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608

Santa Clara

Santa Clara, CA Tel: 408-961-6444 Fax: 408-961-6445

Toronto

Mississauga, Ontario,

Canada

Tel: 905-673-0699 Fax: 905-673-6509

#### ASIA/PACIFIC

**Asia Pacific Office** 

Suites 3707-14, 37th Floor Tower 6, The Gateway Harbour City, Kowloon Hong Kong

Tel: 852-2401-1200 Fax: 852-2401-3431

**Australia - Sydney** Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

**China - Beijing** Tel: 86-10-8569-7000 Fax: 86-10-8528-2104

**China - Chengdu** Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

**China - Chongqing** Tel: 86-23-8980-9588 Fax: 86-23-8980-9500

**China - Hangzhou** Tel: 86-571-2819-3187 Fax: 86-571-2819-3189

China - Hong Kong SAR Tel: 852-2401-1200 Fax: 852-2401-3431

**China - Nanjing** Tel: 86-25-8473-2460 Fax: 86-25-8473-2470

**China - Qingdao** Tel: 86-532-8502-7355 Fax: 86-532-8502-7205

**China - Shanghai** Tel: 86-21-5407-5533 Fax: 86-21-5407-5066

**China - Shenyang** Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

**China - Shenzhen** Tel: 86-755-8203-2660 Fax: 86-755-8203-1760

**China - Wuhan** Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

**China - Xian** Tel: 86-29-8833-7252 Fax: 86-29-8833-7256

**China - Xiamen** Tel: 86-592-2388138 Fax: 86-592-2388130

**China - Zhuhai** Tel: 86-756-3210040 Fax: 86-756-3210049

#### ASIA/PACIFIC

India - Bangalore Tel: 91-80-3090-4444 Fax: 91-80-3090-4123

India - New Delhi Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune Tel: 91-20-2566-1512 Fax: 91-20-2566-1513

**Japan - Osaka** Tel: 81-66-152-7160 Fax: 81-66-152-9310

**Japan - Yokohama** Tel: 81-45-471- 6166 Fax: 81-45-471-6122

Korea - Daegu

Tel: 82-53-744-4301 Fax: 82-53-744-4302 **Korea - Seoul** Tel: 82-2-554-7200

Fax: 82-2-558-5932 or 82-2-558-5934

**Malaysia - Kuala Lumpur** Tel: 60-3-6201-9857 Fax: 60-3-6201-9859

**Malaysia - Penang** Tel: 60-4-227-8870 Fax: 60-4-227-4068

**Philippines - Manila** Tel: 63-2-634-9065 Fax: 63-2-634-9069

**Singapore** Tel: 65-6334-8870 Fax: 65-6334-8850

**Taiwan - Hsin Chu** Tel: 886-3-5778-366 Fax: 886-3-5770-955

**Taiwan - Kaohsiung** Tel: 886-7-536-4818 Fax: 886-7-330-9305

**Taiwan - Taipei** Tel: 886-2-2500-6610 Fax: 886-2-2508-0102

**Thailand - Bangkok** Tel: 66-2-694-1351 Fax: 66-2-694-1350

#### **EUROPE**

Austria - Wels
Tel: 43-7242-2244-39
Fax: 43-7242-2244-393

**Denmark - Copenhagen** Tel: 45-4450-2828

Fax: 45-4485-2829
France - Paris
Tel: 33-1-69-53-63-20

Fax: 33-1-69-30-90-79

Germany - Munich

Germany - Munich Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Italy - Milan Tel: 39-0331-742611 Fax: 39-0331-466781

**Netherlands - Drunen** Tel: 31-416-690399 Fax: 31-416-690340

**Spain - Madrid** Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

**UK - Wokingham** Tel: 44-118-921-5869 Fax: 44-118-921-5820

11/29/11